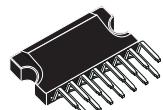


## 5W+5W AMPLIFIER WITH DC VOLUME CONTROL

### PRODUCT PREVIEW

- 5+5W OUTPUT POWER  
 $R_L = 8\Omega$  @THD = 10%  $V_{CC} = 22V$
- ST-BY AND MUTE FUNCTIONS
- LOW TURN-ON TURN-OFF POP NOISE
- LINEAR VOLUME CONTROL DC COUPLED WITH POWER OP. AMP.
- NO BOUCHEROT CELL
- NO ST\_BY RC INPUT NETWORK
- SINGLE SUPPLY RANGING UP TO 35V
- SHORT CIRCUIT PROTECTION
- THERMAL OVERLOAD PROTECTION
- INTERNALLY FIXED GAIN
- SOFT CLIPPING
- VARIABLE OUTPUT AFTER VOLUME CONTROL CIRCUIT
- CLIPWATT 15 PACKAGE

### MULTIPOWER BI50II TECHNOLOGY



**Clipwatt 15**  
ORDERING NUMBER: TDA7496SA

amplifier assembled in the Clipwatt 15 package, specially designed for high quality sound TV applications.

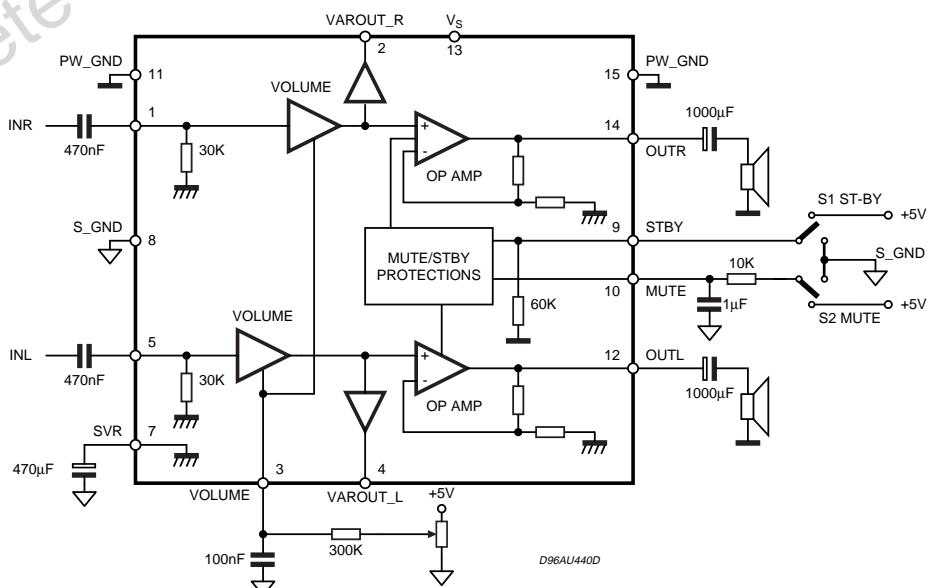
Features of the TDA7496SA include linear volume control Stand-by and Mute functions.

The TDA7496SA is pin to pin compatible with TDA7496, TDA7496S, TDA7496SA, TDA7495, TDA7495SA, TDA7494S, TDA7494SA.

### DESCRIPTION

The TDA7496SA is a stereo 5+5W class AB power

### BLOCK DIAGRAM

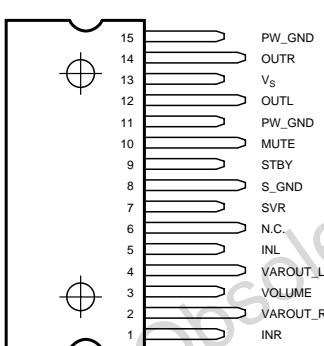


# TDA7496SA

## ABSOLUTE MAXIMUM RATINGS

| Symbol               | Parameter   | Value      | Unit            |
|----------------------|---|------------|-----------------|
| V <sub>S</sub>       | DC Supply Voltage                                 | 35         | V               |
| V <sub>IN</sub>      | Maximum Input Voltage                             | 8          | V <sub>pp</sub> |
| P <sub>tot</sub>     | Total Power Dissipation (T <sub>amb</sub> = 70°C) | 16         | W               |
| T <sub>amb</sub>     | Ambient Operating Temperature (1)                 | 0 to 70    | °C              |
| T <sub>stg, TJ</sub> | Storage and Junction Temperature                  | -40 to 150 | °C              |
| V <sub>3</sub>       | Volume Control DC Voltage                         | 7          | V               |

## PIN CONNECTION (top view)



## THERMAL DATA

| Symbol                 | Parameter                                | Value                | Unit |
|------------------------|--|----------------------|------|
| R <sub>th j-case</sub> | Thermal Resistance junction-case         | Typ. = 4.5; Max. = 5 | °C/W |
| R <sub>th j-amb</sub>  | Thermal Resistance junction-ambient Max. | 48                   | °C/W |

## ELECTRICAL CHARACTERISTICS

(Refer to the test circuit R<sub>L</sub> = 8Ω, f = 1KHz, R<sub>g</sub> = 50Ω, V<sub>S</sub> = 22V, T<sub>amb</sub> = 25°C)

| Symbol            | Parameter                                  | Test Condition  | Min. | Typ.       | Max. | Unit |
|-------------------|--|---|------|------------|------|------|
| V <sub>S</sub>    | Supply Voltage Range                       |   | 10   |            | 32   | V    |
| I <sub>q</sub>    | Total Quiescent Current                    |   |      | 25         | 50   | mA   |
| DCV <sub>os</sub> | Output DC Offset Referred to SVR Potential | No Input Signal   |      | 200        |      | mV   |
| V <sub>O</sub>    | Quiescent Output Voltage                   |   |      | 11         |      | V    |
| P <sub>O</sub>    | Output Power                               | THD = 10%; R <sub>L</sub> = 8Ω;<br>THD = 1%; R <sub>L</sub> = 8Ω;   | 5    | 5.5<br>4   |      | W    |
|                   |  | THD = 10%; R <sub>L</sub> = 4Ω; V <sub>S</sub> = 12V<br>THD = 1%; R <sub>L</sub> = 4Ω; V <sub>S</sub> = 12V |      | 2.1<br>1.0 |      | W    |
| THD               | Total Harmonic Distortion                  | G <sub>V</sub> = 30dB; P <sub>O</sub> = 1W; f = 1KHz  |      |            | 0.4  | %    |

**ELECTRICAL CHARACTERISTICS** (continued)(Refer to the test circuit  $R_L = 8\Omega$ ,  $f = 1\text{KHz}$ ,  $R_g = 50\Omega$ ,  $V_S = 22\text{V}$ ,  $T_{amb} = 25^\circ\text{C}$ )

| Symbol                 | Parameter                     | Test Condition  | Min. | Typ. | Max. | Unit |
|------------------------|-------------------------------|---|------|------|------|------|
| I <sub>peak</sub>      | Output Peak Current           | (internally limited)  | 1.0  | 1.3  |      | A    |
| V <sub>IN</sub>        | Input Signal                  |   |      |      | 2.8  | Vrms |
| G <sub>V</sub>         | Closed Loop Gain              | V <sub>OL Ctrl</sub> >4.5V  | 28.5 | 30   | 31.5 | dB   |
| G <sub>VLine</sub>     | Monitor Out Gain              | V <sub>OL Ctrl</sub> >4.5V; Z <sub>load</sub> >30KΩ                             | -1.5 | 0    | 1.5  | dB   |
| A <sub>Min VOL</sub>   | Attenuation at Minimum Volume | V <sub>OL Ctrl</sub> <0.5V  | 80   |      |      | dB   |
| BW                     |                               |   |      | 0.6  |      | MHz  |
| e <sub>N</sub>         | Total Output Noise            | f = 20Hz to 22KHz<br>PLAY, max volume   |      | 500  | 800  | µV   |
|                        |                               | f = 20Hz to 22KHz<br>PLAY, max attenuation                                      |      | 100  | 250  | µV   |
|                        |                               | f = 20Hz to 22KHz MUTE  |      | 60   | 150  | µV   |
| SR                     | Slew Rate                     |   | 5    | 8    |      | V/µs |
| R <sub>i</sub>         | Input Resistance              |   | 22.5 | 30   |      | KΩ   |
| R <sub>Var Out</sub>   | Variable Output Resistance    |   |      | 30   | 100  | Ω    |
| R <sub>L Var Out</sub> | Variable Output Load          |   | 2    |      |      | KΩ   |
| SVR                    | Supply Voltage Rejection      | f = 1KHz; max volume<br>C <sub>SVR</sub> = 470µF; V <sub>RIP</sub> = 1Vrms      | 35   | 39   |      | dB   |
|                        |                               | f = 1KHz; max attenuation<br>C <sub>SVR</sub> = 470µF; V <sub>RIP</sub> = 1Vrms | 55   | 65   |      | dB   |
| T <sub>M</sub>         | Thermal Muting                |   |      | 150  |      | °C   |
| T <sub>S</sub>         | Thermal Shut-down             |   |      | 160  |      | °C   |

**MUTE & INPUT SELECTION FUNCTIONS**

|                       |                              |   |     |     |     |    |
|-----------------------|------------------------------|---|-----|-----|-----|----|
| V <sub>ST-ON</sub>    | Stand-by ON Threshold        |   | 3.5 |     |     | V  |
| V <sub>ST-OFF</sub>   | Stand-by OFF Threshold       |   |     |     | 1.5 | V  |
| V <sub>MUTEON</sub>   | Mute ON threshold            |   | 3.5 |     |     | V  |
| V <sub>MUTEOFF</sub>  | Mute OFF threshold           |   |     |     | 1.5 | V  |
| AMUTE                 | Mute Attenuation             |   | 50  | 65  |     | dB |
| I <sub>qST-BY</sub>   | Quiescent Current @ Stand-by |   |     | 0.6 | 1   | mA |
| I <sub>stbyBIAS</sub> | Stand-by bias current        | Stand by ON: V <sub>ST-BY</sub> = 5V;<br>V <sub>mute</sub> = 5V |     | 80  |     | µA |
|                       |                              | Play or Mute  | -20 | -5  |     | µA |
| I <sub>muteBIAS</sub> | Mute Bias Current            | Mute  |     | 1   | 5   | µA |
|                       |                              | Play  |     | 0.2 | 2   | µA |

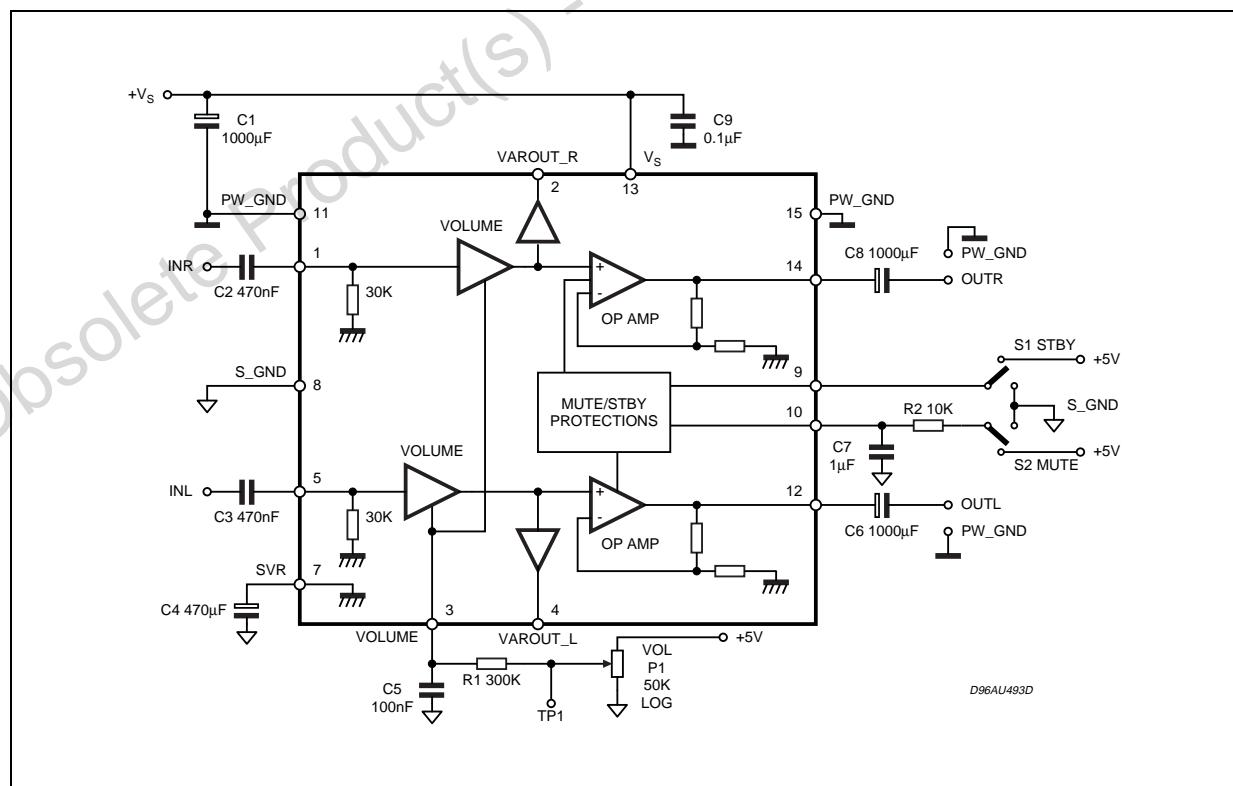
**TDA7496SA**

## **APPLICATION SUGGESTIONS**

The recommended values of the external components are those shown on the application circuit of figure 1. Different values can be used, the following table can help the designer.

| COMPONENT | SUGGESTION VALUE | PURPOSE                      | LARGER THAN SUGGESTION        | SMALLER THAN SUGGESTION        |
|-----------|------------------|------------------------------|-------------------------------|--------------------------------|
| R1        | 300K             | Volume Control Circuit       | Larger volume regulation time | Smaller volume regulation time |
| R2        | 10K              | Mute time constant           | Larger mute on/off time       | Smaller mute on/off time       |
| P1        | 50K              | Volume Control Circuit       |                               |                                |
| C1        | 1000µF           | Supply voltage bypass        |                               | Danger of oscillation          |
| C2        | 470nF            | Input DC decoupling          | Lower low frequency cutoff    | Higher low frequency cutoff    |
| C3        | 470nF            | Input DC decoupling          | Lower low frequency cutoff    | Higher low frequency cutoff    |
| C4        | 470µF            | Ripple rejection             | Better SVR                    | Worse SVR                      |
| C5        | 100nF            | Volume control time constant | Larger volume regulation time | Smaller volume regulation time |
| C6        | 1000µF           | Output DC decoupling         | Lower low frequency cutoff    | Higher low frequency cutoff    |
| C7        | 1µF              | Mute time constant           | Larger mute on/off time       | Smaller mute on/off time       |
| C8        | 1000µF           | Output DC decoupling         | Lower low frequency cutoff    | Higher low frequency cutoff    |
| C9        | 100nF            | Supply voltage bypass        |                               | Danger of oscillation          |

**Figure 1. Application Circuit**

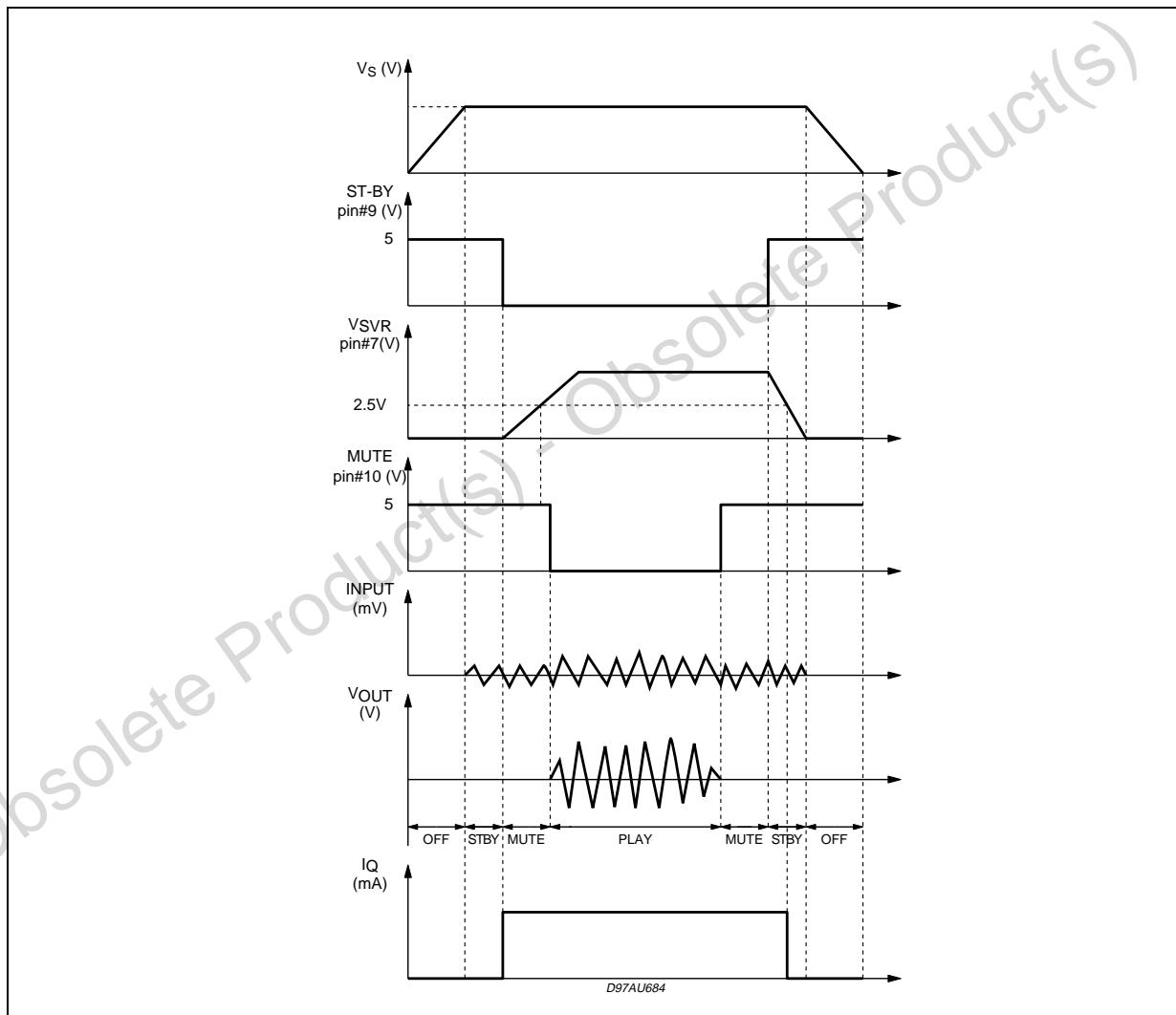


**MUTE STAND-BY TRUTH TABLE**

| MUTE | St-BY | OPERATING CONDITION |
|------|-------|---------------------|
| H    | H     | STAND-BY            |
| L    | H     | STAND-BY            |
| H    | L     | MUTE                |
| L    | L     | PLAY                |

Turn ON/OFF Sequences (for optimizing the POP performances)

**Figure 1. USING ONLY THE MUTE FUNCTION**

**USING ONLY THE MUTE FUNCTION**

To simplify the application, the stand-by pin can be connected directly to Ground. During the ON/OFF transitions is recommended to respect the following conditions:

- At the turn-on the transition mute to mute - play must be made when the SVR pin is higher than 2.5V
- At the turn-off the TDA7496A must be brought to mute from the play condition when the SVR pin is higher than 2.5V.

## TDA7496SA

Figure 2. P.C.B. and Component layoutPCB and Component Layout

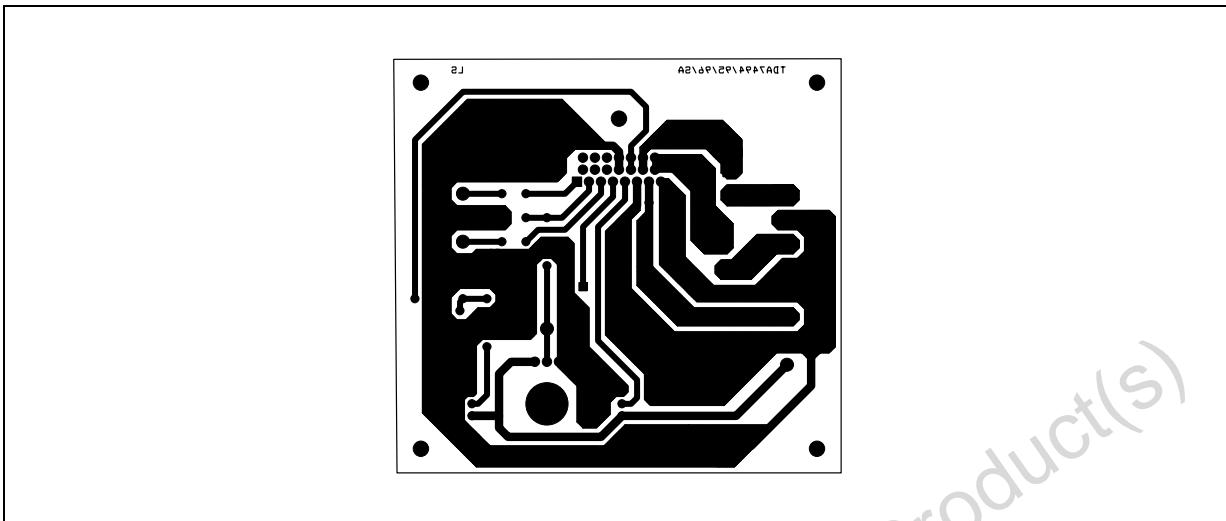
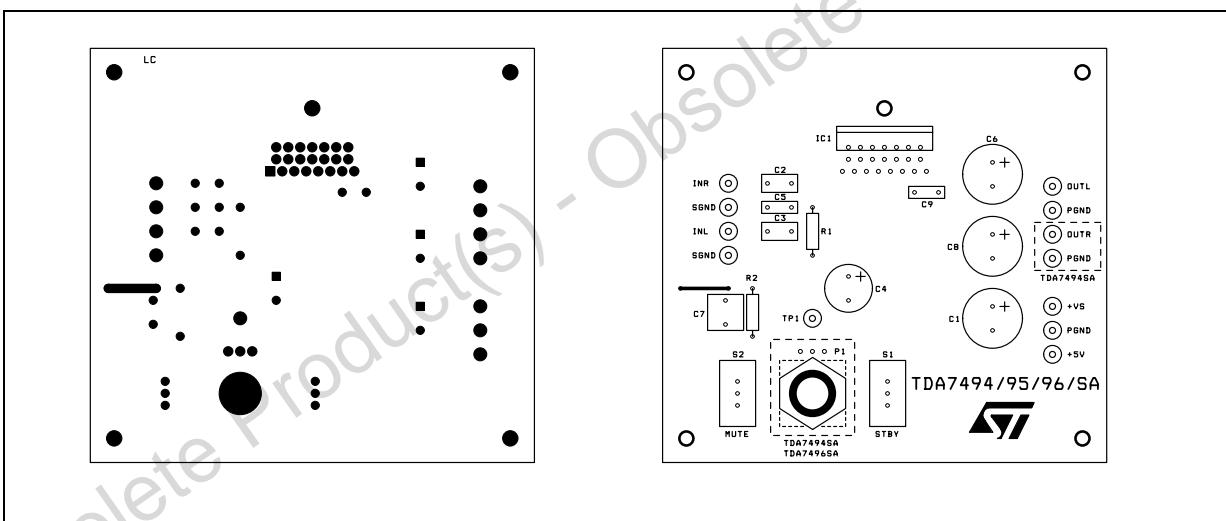
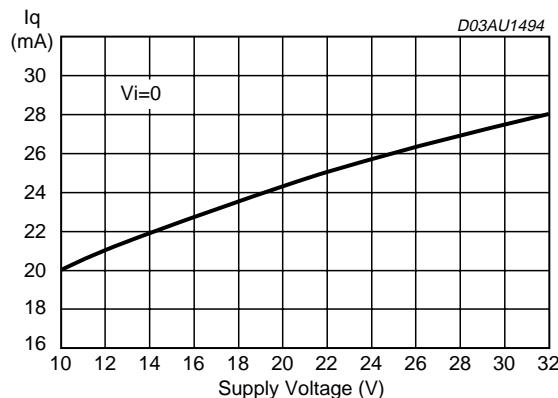


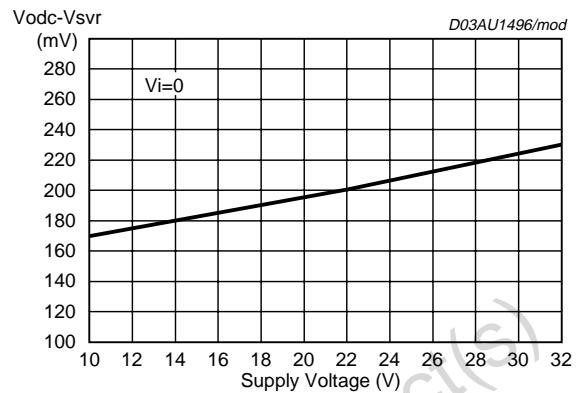
Figure 3.



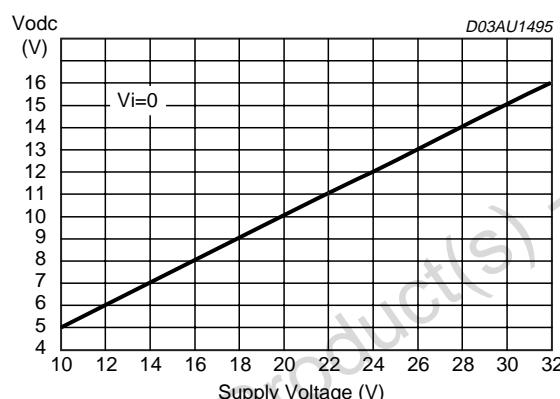
**Figure 4. Quiescent Current vs. Supply Voltage**



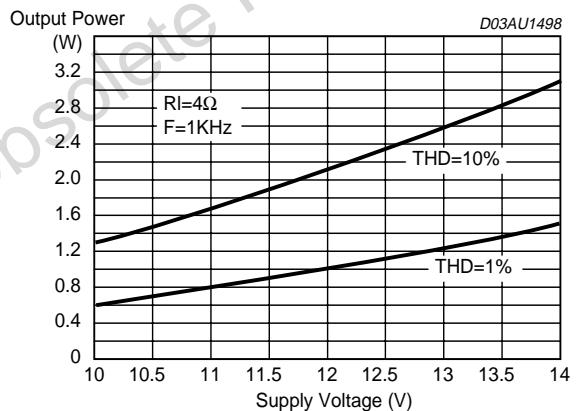
**Figure 7. Output DC Offset vs. Supply Voltage**



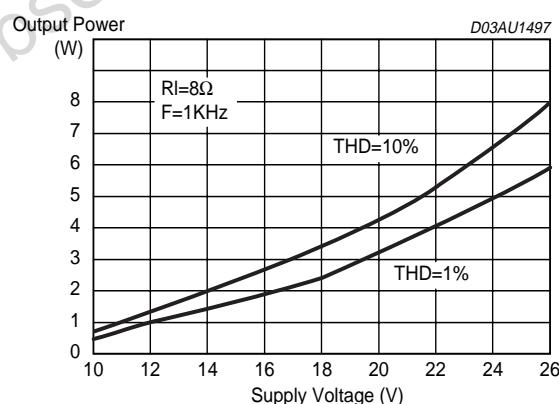
**Figure 5. Output Dc Offset vs. Supply Voltage**



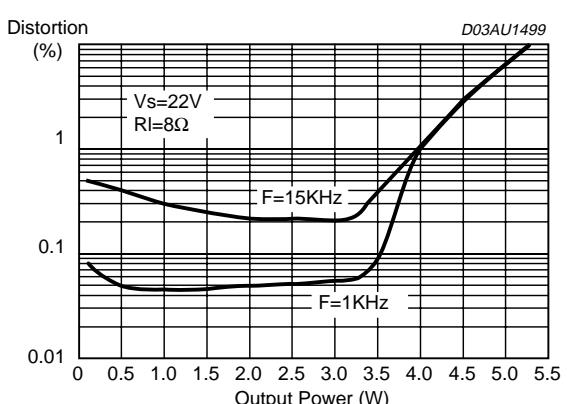
**Figure 8. Output Power vs Supply Voltage**



**Figure 6. Output Power vs. Supply Voltage**

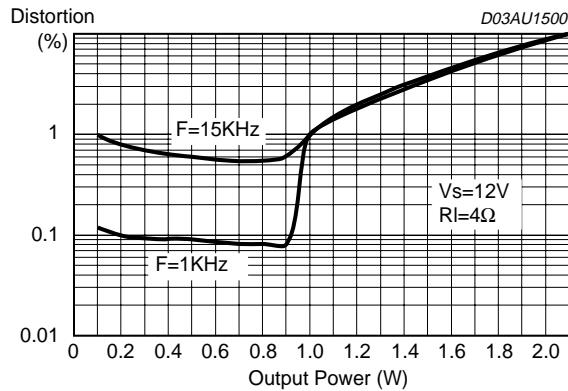


**Figure 9. Distortion vs Output Power**

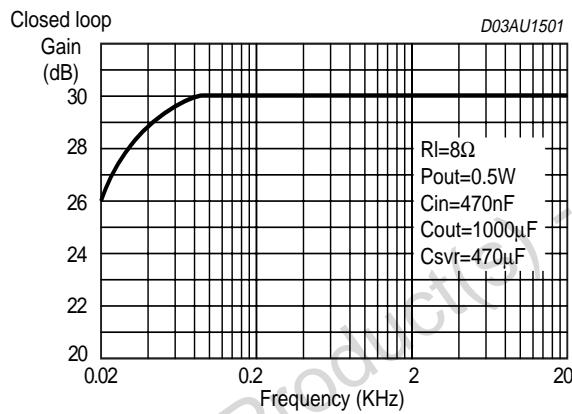


## TDA7496SA

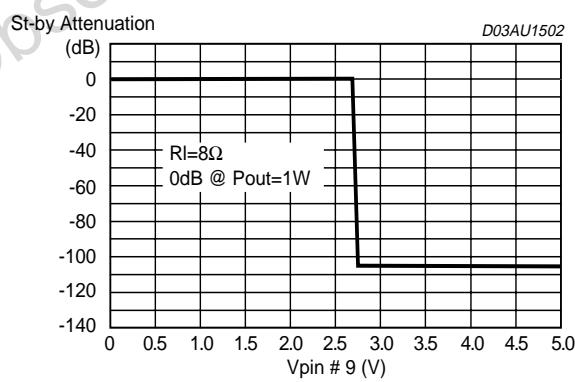
**Figure 10. Distortion vs Output Power**



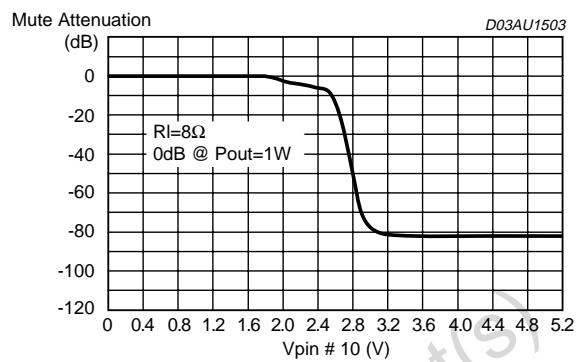
**Figure 11. Closed Loop Gain vs. Frequency**



**Figure 12. St-By Attenuation vs Vpin 9**

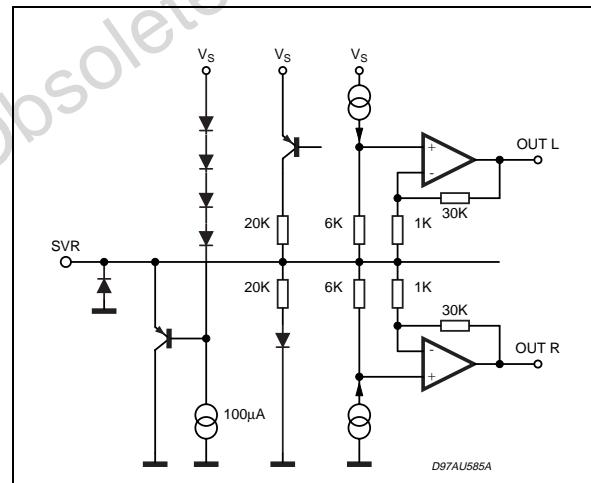


**Figure 13. Mute Attenuation vs Vpin 10**



## PINS DESCRIPTION

**Figure 14. PIN SVR**



**Figure 15. PINS: INL,INR**

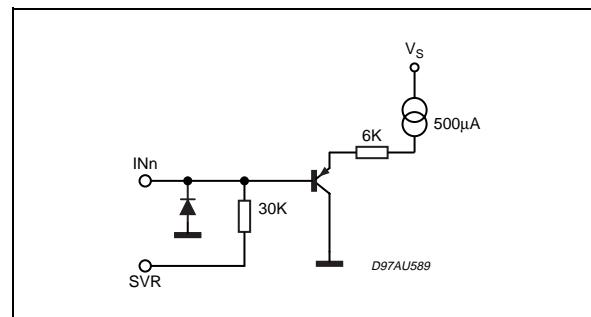


Figure 17. PIN ST-BY

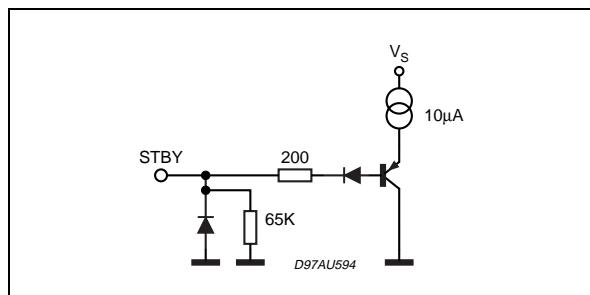


Figure 18. PIN: MUTE

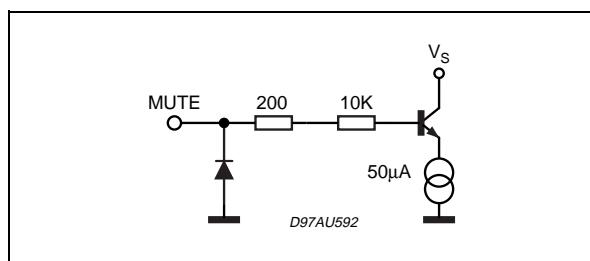


Figure 19. PINS: OUT R, OUT L

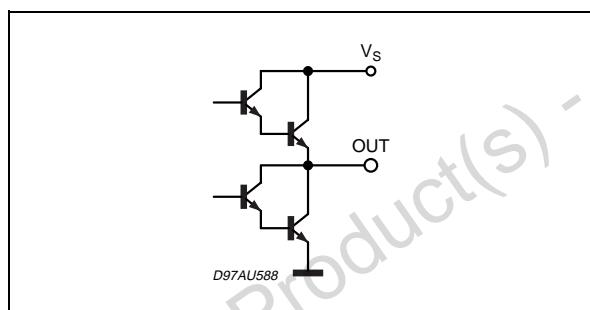


Figure 20. PINS: VAROUT-L VAROUT-R

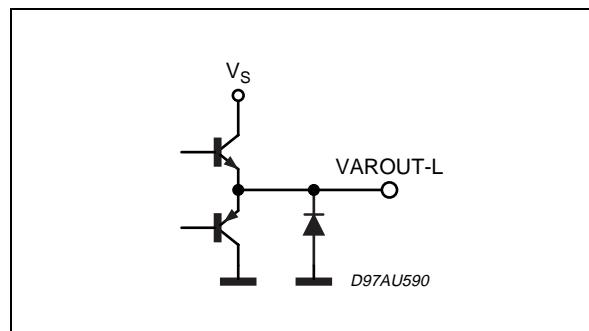


Figure 21. PIN: VOLUME

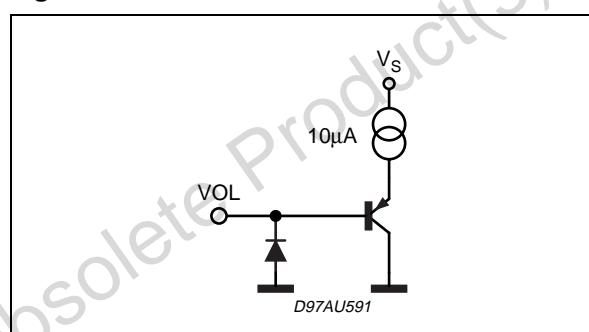
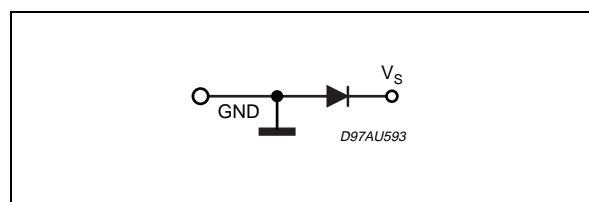


Figure 22. PINS: PW-GND, S-GND



### HEAT SINK DIMENSIONING:

In order to avoid the thermal protection intervention, that is placed approximatively at  $T_j = 150^\circ\text{C}$ , it is important the dimensioning of the Heat Sinker  $R_{Th}$  ( $^\circ\text{C}/\text{W}$ ).

The parameters that influence the dimensioning are:

- Maximum dissipated power for the device ( $P_{dmax}$ )
- Max thermal resistance Junction to case ( $R_{Th j-c}$ )
- Max. ambient temperature  $T_{amb}$  max
- Quiescent current  $I_q$  (mA)

Example:

$V_{CC} = 22\text{V}$ ,  $R_{load} = 8\text{ohm}$ ,  $R_{Th j-c} = 5 \text{ }^\circ\text{C}/\text{W}$  ,  $T_{amb}$  max =  $50^\circ\text{C}$

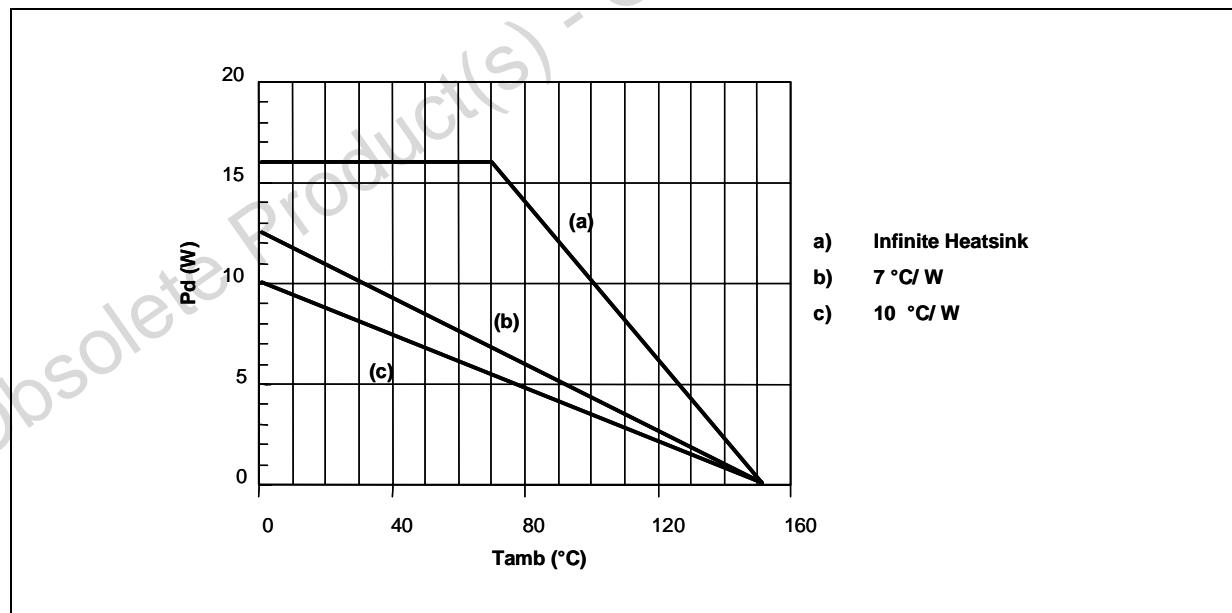
$$P_{dmax} = (\text{Nº channels}) \cdot \frac{V_{CC}^2}{2\pi^2 \cdot R_{load}} + I_q \cdot V_{CC}$$

$$P_{dmax} = 2 \cdot (3.0) + 0.5 = 6.5 \text{ W}$$

$$(\text{Heat Sinker}) R_{Th c-a} = \frac{150 - T_{amb} \text{ max}}{P_{dmax}} - R_{Th j-c} = \frac{150 - 50}{6.5} - 5.0 = 10 \text{ }^\circ\text{C}/\text{W}$$

In figure 23 is shown the Power derating curve for the device.

**Figure 23. Power derating curve**



### Clipwatt Assembling Suggestions

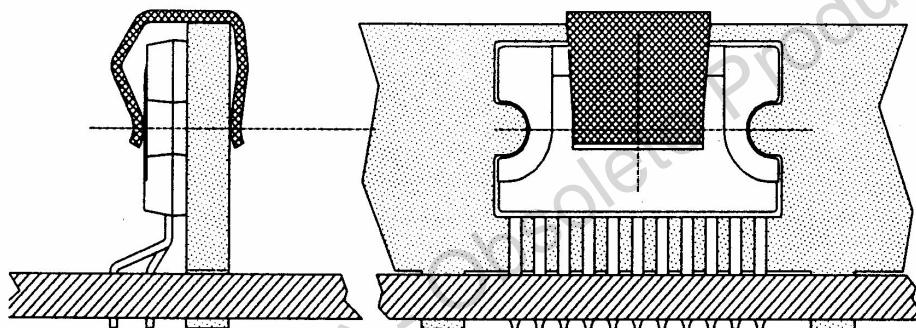
The suggested mounting method of Clipwatt on external heat sink, requires the use of a clip placed as much as possible in the plastic body center, as indicated in the example of figure 24.

A thermal grease can be used in order to reduce the additional thermal resistance of the contact between package and heatsink.

A pressing force of 7 - 10 Kg gives a good contact and the clip must be designed in order to avoid a maximum contact pressure of 15 Kg/mm<sup>2</sup> between it and the plastic body case.

As example , if a 15Kg force is applied by the clip on the package , the clip must have a contact area of 1mm<sup>2</sup> at least.

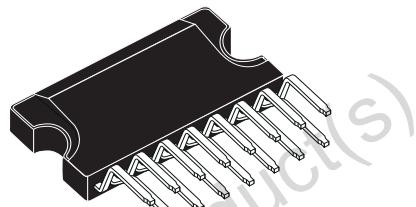
**Figure 24. Example of right placement of the clip**



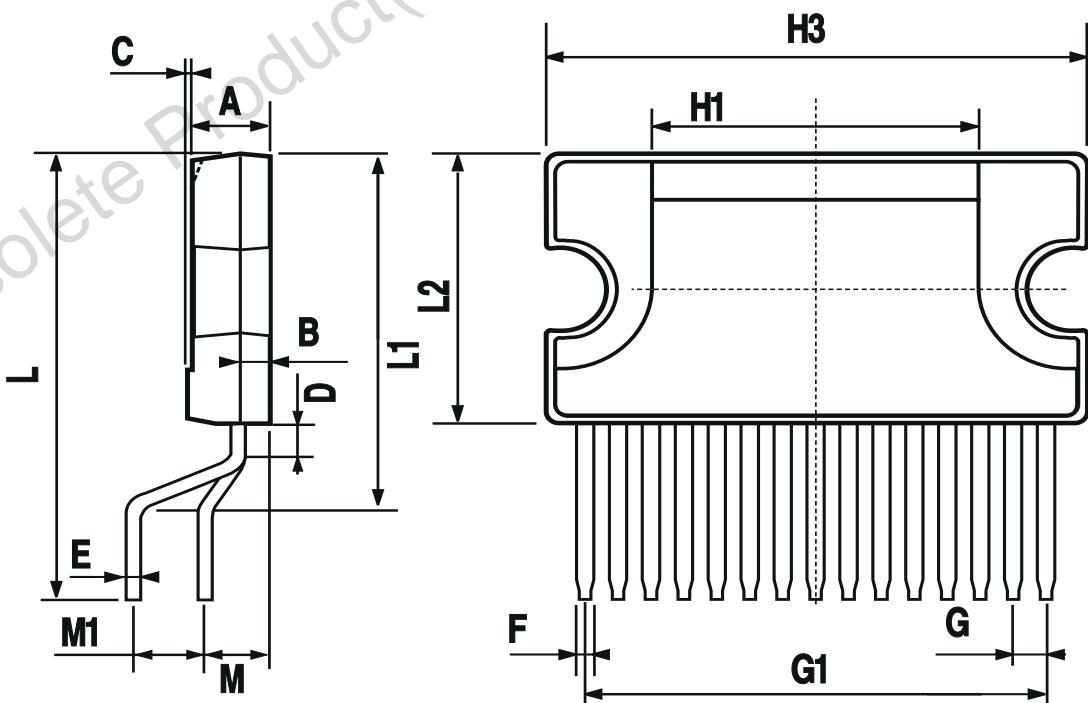
| DIM. | mm    |       |       | inch  |       |       |
|------|-------|-------|-------|-------|-------|-------|
|      | MIN.  | TYP.  | MAX.  | MIN.  | TYP.  | MAX.  |
| A    |       |       | 3.2   |       |       | 0.126 |
| B    |       |       | 1.05  |       |       | 0.041 |
| C    |       | 0.15  |       |       | 0.006 |       |
| D    |       | 1.55  |       |       | 0.061 |       |
| E    | 0.49  |       | 0.55  | 0.019 |       | 0.022 |
| F    | 0.67  |       | 0.73  | 0.026 |       | 0.029 |
| G    | 1.14  | 1.27  | 1.4   | 0.045 | 0.050 | 0.055 |
| G1   | 17.57 | 17.78 | 17.91 | 0.692 | 0.700 | 0.705 |
| H1   |       | 12    |       |       | 0.480 |       |
| H2   |       | 18.6  |       |       | 0.732 |       |
| H3   | 19.85 |       |       | 0.781 |       |       |
| L    |       | 17.95 |       |       | 0.707 |       |
| L1   |       | 14.45 |       |       | 0.569 |       |
| L2   | 10.7  | 11    | 11.2  | 0.421 | 0.433 | 0.441 |
| L3   |       | 5.5   |       |       | 0.217 |       |
| M    |       | 2.54  |       |       | 0.100 |       |
| M1   |       | 2.54  |       |       | 0.100 |       |

## OUTLINE AND MECHANICAL DATA

Weight: 1.92gr



Clipwatt15



0044538

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